

**PATENT ASSIGNMENT**

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NATURE OF CONVEYANCE:	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
Duk-Young Jung	09/29/2009
Jae Eok Han	09/29/2009
Juyeon Chang	09/29/2009
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<b>Postal Code:</b>	440-746
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<b>Application Number:</b>	12595330
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<b>NAME OF SUBMITTER:</b>	Brian R. Morrison
<b>Total Attachments: 2</b> source=ExecutedAssignment_S201120002#page1.tif source=ExecutedAssignment_S201120002#page2.tif	

OP \$40.00 12595330

# ASSIGNMENT

Attorney Docket No.

DOCKET NO. S201.12-0002

First Named Inventor : **JUNG, Duk-Young**

Title : **SYNTHESIS OF I-III-VI2 NANOPARTICLES AND FABRICATION OF POLYCRYSTALLINE ABSORBER LAYERS**

WHEREAS, JUNG, Duk-Young of Gyeonggi-do, KR; HAN, Jae Eok of Gyeonggi-do, KR; CHANG, Juyeon of Seoul, KR, have invented certain new and useful improvements as described in an application entitled **SYNTHESIS OF I-III-VI2 NANOPARTICLES AND FABRICATION OF POLYCRYSTALLINE ABSORBER LAYERS** for Letters Patent of the United States, the application having been executed on even date herewith, and/or being identifiable in the United States Patent and Trademark Office by Application No. 12/595,330, filed October 9, 2009; and

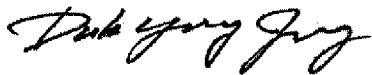
WHEREAS, SUNGKYUNKWAN UNIVERSITY Foundation for Corporate Collaboration, a corporation organized and existing under the laws of Republic of Korea, and having offices Sungkyunkwan University, 300 Cheoncheon-dong, Jangan-gu, Suwon, Gyeonggi-do 440-746, Republic of Korea, ("Assignee") is desirous of acquiring the entire right, title and interest in and to the invention, the application, and any and all Letters Patent or similar legal protection, foreign or domestic, to be obtained therefor;

NOW, THEREFORE, for good and valuable consideration, the receipt and adequacy of which is hereby acknowledged, I transfer to Assignee, its successors and assigns, my entire right, title and interest in and to the invention, the above-identified application, corresponding domestic and foreign applications, all Letters Patent or similar legal protection issuing thereon, and all rights and benefits under any applicable treaty or convention; and I authorize the Commissioner of Patents and Trademarks of the United States or foreign equivalent thereof to issue the Letters Patent or similar legal protection to the Assignee.

I authorize the Assignee, its successors and assigns, to insert in this instrument the filing date and application number of the application when ascertained.

I authorize the Assignee, its successors and assigns, or anyone it may properly designate, to apply for Letters Patent or similar legal protection, in its own name if desired, in any and all foreign countries.

I represent to the Assignee, its successors and assigns, that I have not and shall not execute any writing or do any act whatsoever conflicting with this Assignment. I, my executors or administrators, will at any time upon request, without additional consideration, but at the expense of the Assignee, its successors and assigns, execute such additional writings and do such additional acts as the Assignee, its successors and assigns, may deem desirable to perfect its enjoyment of this grant, and render all assistance in making application for and obtaining, maintaining, and enforcing the Letters Patent or similar legal protection on the invention in any and all countries.



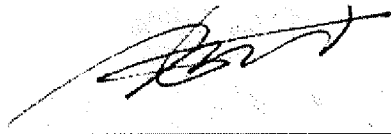
Inventor Signature: Duk-Young JUNG

09/29/2009

Date



Inventor Signature: Jae Eok HAN



\_\_\_\_\_  
Inventor Signature: Juyeon CHANG

\_\_\_\_\_  
Witness Signature

\_\_\_\_\_  
Witness Printed Name